/ Revised record

#

A	2021-4-7		W.15		

#

#

/ Descriptions

)" 567 #
)"#89%/:2 #539;+#<=:00#>:00? :+ @#6%?@A # 2+?/? % 567#+*?;#$:2B:A #

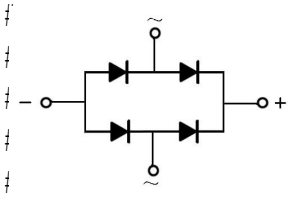
/ Features

50V~1000V 1A
RoHS
<=:00#>:00? :+ @#C*?$#D9;2+?3;E# %0 #F3=+:A ,G(+3)(((F=#73%.:%@#C9%% ;+,)#"E#H?A*#89%A #
C9%% ;+#C:$:1?=?+IE#J3.#73%.:%@#F3=+:A #K%3$E J :@#:;@#13@I#:223%@?;A#.?+*# 3H8#0+:;@:%@
H:=3A ;#/% #$%3@92+!#

/ Applications

.
< ; %:=#$9%$30 !#
#

/ Equivalent Circuit



/ Pinning

#

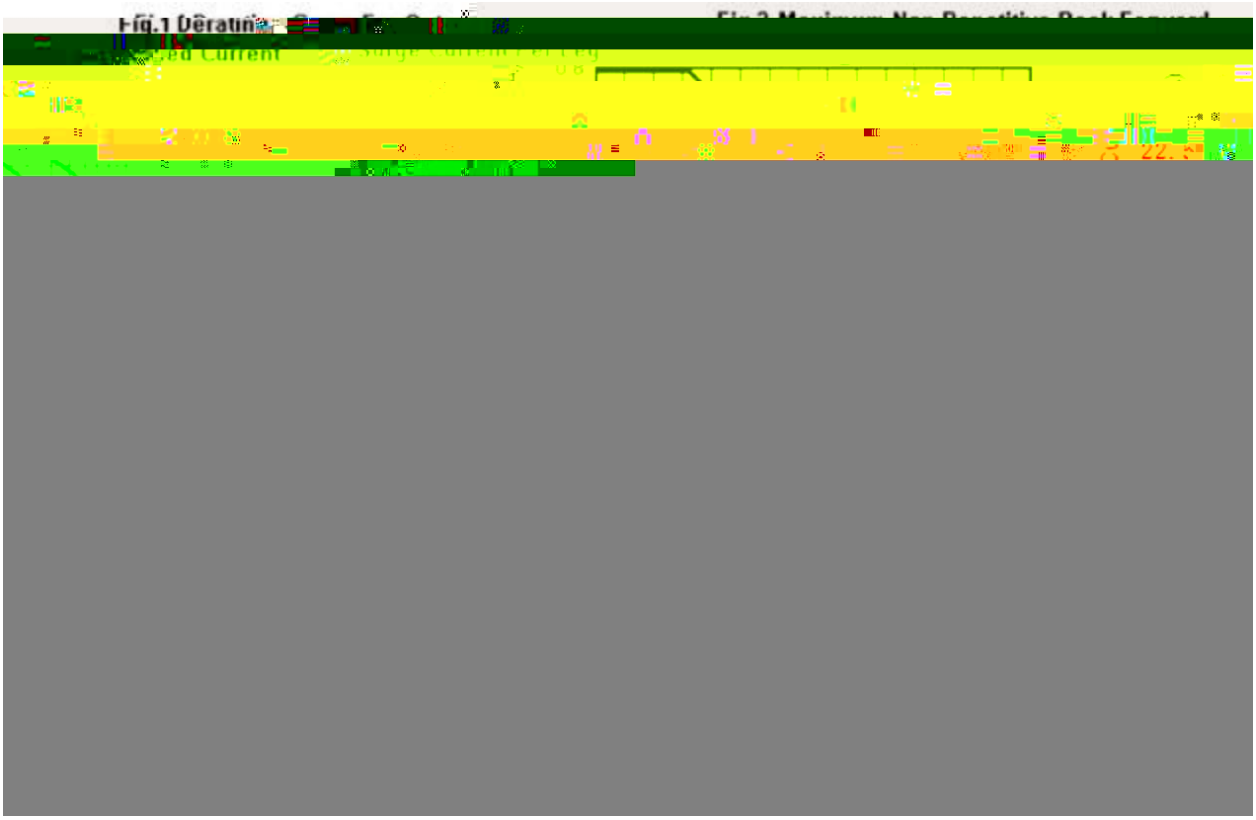



/ Marking#

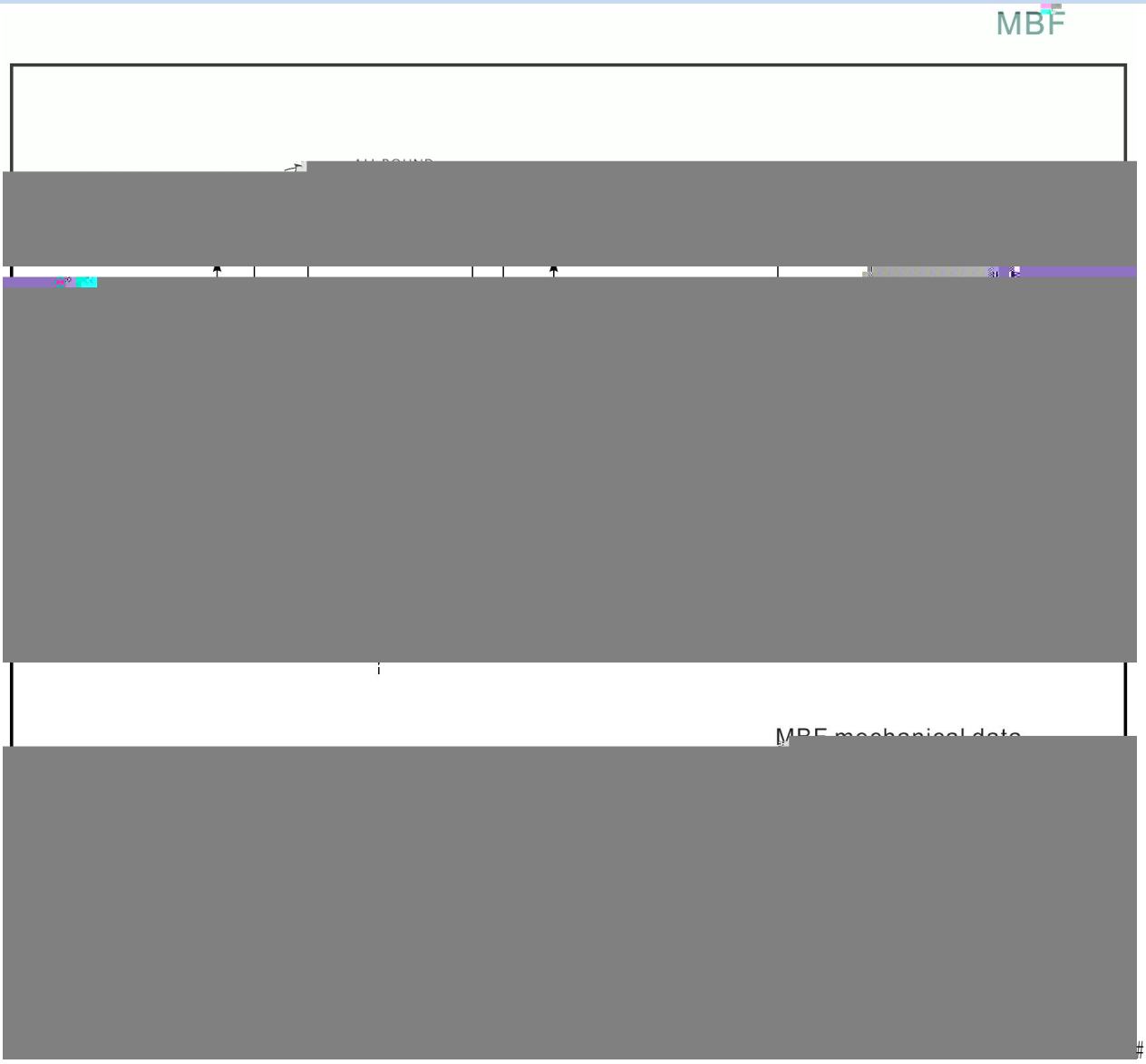
8 #5:%B?;A#L;0+%92+?3;0!#

参数# >:%:4 + %#	符号# 8I413=#	数值# :+?;A#							单位# M;?+#
		56(G7	56)7#	56'7#	56N7#	560O7#	56P7#	56)(7#	
5:Q?494# 29%% ;+#> :B# %0 #F3=+:A #	F 5#	G(#	)((#	'((#	N((#	O((#	P((#	)(((#	F#
5:Q?494# 58#F3=+:A #	F 58#	RG#	S(#	)N(#	'P(#	N'(#	GO(#	S((#	F#
5:Q?494#KC#6=32B?;A#F3=+:A #	F_{KC}#	G(#	)((#	'((#	N((#	O((#	P((#	)(((#	F#
" %:A # 2+?/? @#T9+$9+# C9%% ;+#:+#U:#V#N(℃	$L_{7W"FX}$#	)#							"#
> :B#73%.:%@#89%A # C9%% ;+ÐP!R40#0?;A= # *:=/&0?; &.: #09$ %?4$30 @# 3;#%:+ @#=3:@#	L_{785}#	R(#							"#>U

/ Electrical Characteristic Curve

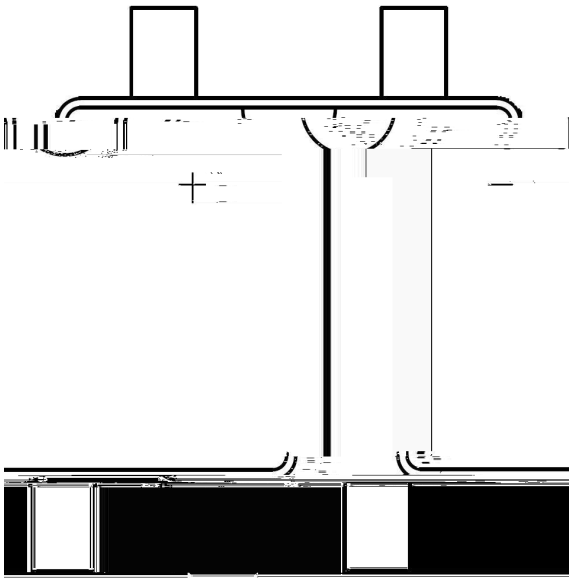


/ Package Dimensions



#

/ Marking Instructions



5 6 (G7 #####

^^^^# # ####

_3+ ,

#

( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)

_3+ ,#

))G( )P(0(a(0 2b# # #)!>% * :+?;A,)G(c)P(℃E#U?4 ,0(ca(0 2!#

' 'NG±G G±(!G0 2b# # '!> :B#U 4$!,'NG±G℃E#K9%:+?3;,G±(!G0 2!#

R ')(℃-0 2!# # # # R! C33-?;A#8$ @,#'c)(℃-0 2!#

#

/ Resistance to Soldering Heat Test Conditions

#

'0(±G℃# #)(±)#0 2!## # # U 4$!,'0(±G℃# # U?4 ,)(±)#0 2#

#

/ Packaging SPEC.

##-## ddJ#

>:2B:A #UI$ # M;?+0 " # $# K?4 ;0?3;## " % &###W9;?+ ' 4 4 R X# η

!#

*++$,-- . . .!/01% 2!234## # # # # # # # # # # # # # # # **6#-#6**